

Form PTO-1595 (Rev. 09/04)
OMB No. 0651-0027 (exp. 6/30/2005)

U.S. DEPARTMENT OF COMMERCE
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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):
MASAKAZU SUZUOKI (05/07/2001) AND
TAKESHI YAMAZAKI (05/10/2001)

Execution Date(s): In parentheses after inventor name
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: SONY COMPUTER ENTERTAINMENT INC.

Internal Address: _____
Street Address:
2-6-21, Minami-Aoyama
Minato-ku
Tokyo
107-0062
JAPAN

City: _____
State: _____
Country: _____ Zip: _____
Additional name(s) & address(es) attached: Yes No

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

4. Application or patent number(s):
A. Patent Application No.(s)
10/967,579
Additional numbers attached? Yes No

This document is being filed together with a new application.
B. Patent No.(s)

 Yes No

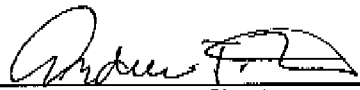
5. Name and address to whom correspondence concerning document should be mailed:
Name: Andrew T. Zidel
LERNER, DAVID, LITTENBERG,
KRUMHOLZ & MENTLIK, LLP
Internal Address: Atty. Dkt.:
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City: Westfield
State: NJ Zip: 07090
Phone Number: (908) 518-6385
Fax Number: (908) 654-7866
Email Address: azidel@ldlkm.com

6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information
a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number 12-1095
Authorized User Name Andrew T. Zidel

9. Signature:

Signature _____ Date May 3, 2005
Andrew T. Zidel - 45,256
Name of Person Signing _____ Total number of pages including cover sheet, attachments, and documents:

561598 1.DOC

CH \$40.00 121095 10967579

Docket Number: SCEI 3.0-056
SCEI Ref. No.: SC00198US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

MEMORY PROTECTION SYSTEM AND METHOD FOR COMPUTER ARCHITECTURE FOR BROADBAND NETWORKS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo, 107-0052 Japan, (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 09/816,020, Filing Date: March 22, 2001.

This assignment executed on the dates indicated below.

Masakazu Suzuki
Name of First or Sole Inventor

May 7, 2001
Execution Date of U.S. Patent Application

Tokyo, Japan
Residence of First or Sole Inventor

M. Suzuki
Signature of First or Sole Inventor

May 7, 2001
Date of this Assignment

PATENT
REEL: 016188 FRAME: 0642

Docket Number: SCEI 3.0-056

Takeshi Yamazaki

May, 10, 2001

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Tokyo

Japan

Residence of Second Joint Inventor

Takeshi Yamazaki

May, 10, 2001

Signature of Second Joint Inventor

Date of this Assignment

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Residence of Third Joint Inventor

Signature of Third Joint Inventor

Date of this Assignment

Name of Fourth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fourth Joint Inventor

Signature of Fourth Joint Inventor

Date of this Assignment

Name of Fifth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fifth Joint Inventor

Signature of Fifth Joint Inventor

Date of this Assignment

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